

UDFN10 3x3, 0.5P CASE 506AT-01 **ISSUE A**

DATE 29 JUN 2007

NOTES:

- IOIES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.25 AND 0.30mm FROM TERMINAL.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	NOM	MAX
Α	0.45	0.50	0.55
A1	0.00	0.03	0.05
A3	0.127 REF		
b	0.18	0.25	0.30
D	3.00 BSC		
D2	2.40	2.50	2.60
Е	3.00 BSC		
E2	1.70	1.80	1.90
е	0.50 BSC		
K	0.19 TYP		
L	0.30	0.40	0.50

GENERIC MARKING DIAGRAM*



= Assembly Location Α

= Wafer Lot = Year = Work Week W = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

*For additional information on our Pb-Free strategy and soldering
details, please download the ON Semiconductor Soldering and
Mounting Techniques Reference Manual, SOLDERRM/D.

-0.5000 PITCH

DIMENSIONS: MILLIMETERS

10X 0.5651

10X

0.3008

DESCRIPTION:	UDFN10 3X3, 0.5P		PAGE 1 OF 2
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